



# PCle® 3.0 Clock Generator with 4 HCSL Outputs

#### **Features**

- → PCIe® 3.0 complaint
  - PCIe 3.0 Phase jitter: 0.48ps RMS (High Freq. Typ.)
- → LVDS compatible outputs
- ➤ Supply voltage of 3.3V ±5%
- → 25MHz crystal or clock input frequency
- → HCSL outputs, 0.7V Current mode differential pair
- → Jitter 40ps cycle-to-cycle (typ)
- → Spread of -0.5%, -1.0%, -1.5%, and no spread
- → Industrial temperature range
- → Spread Bypass option available
- → Spread and frequency selection via external pins
- → Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- → Halogen and Antimony Free. "Green" Device (Note 3)
- → For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative.

https://www.diodes.com/quality/product-definitions/

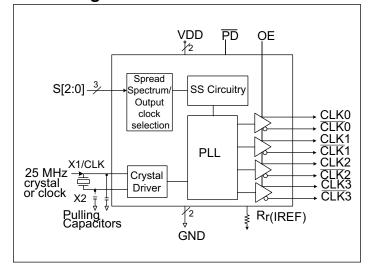
- → Packaging: (Pb-free and Green)
  - 20-pin, TSSOP (L)

## **Description**

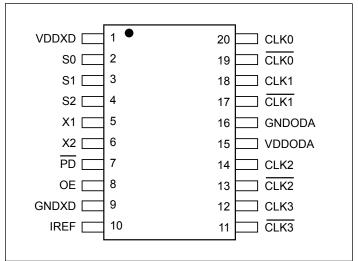
The PI6C557-05B is a spread spectrum clock generator compliant to PCI Express\* 3.0 and Ethernet requirements. The device is used for PC or embedded systems to substantially reduce Electromagnetic Interference (EMI).

The PI6C557-05B provides four differential (HCSL) or LVDS spread spectrum outputs. The PI6C557-05B is configured to select spread and clock selection. Using Pericom's patented Phase-Locked Loop (PLL) techniques, the device takes a 25MHz crystal input and produces four pairs of differential outputs (HCSL) at 100MHz and 200MHz clock frequencies. It also provides spread selection of -0.5%, -1.0%, -1.5%, and no spread.

## **Block Diagram**



## **Pin Configuration**



#### **Notes:**

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

1





# **Pin Description**

| Pin # | Pin Name              | I/O Type | Description  |
|-------|-----------------------|----------|--|
| 1     | VDDXD                 | Power    | Connect to a +3.3V source.   |
| 2     | S0                    | Input    | Spread Spectrum Select pin #0. See Spred Spectrum Selec table. Internal pull-up resistor.                |
| 3     | S1                    | Input    | Spread Spectrum Select pin #1. See Spred Spectrum Selec table. Internal pull-up resistor.                |
| 4     | S2                    | Input    | Spread Spectrum Select pin #2. See Spred Spectrum Selec table. Internal pull-up resistor.                |
| 5     | X1                    | Input    | Crystal connection.  |
| 6     | X2                    | Output   | Crystal connection.  |
| 7     | $\overline{	ext{PD}}$ | Input    | Power down. Internal pull-up resistor.   |
| 8     | OE                    | Input    | Output enable. Tri-states output (High=enable outputs); Low=disable outputs). Internal pull-up resister. |
| 9     | GND                   | Power    | Connect to digital circuit ground.   |
| 10    | IREF                  | Output   | Precision resistor attached to this pin is connected to the internal current reference.                  |
| 11    | CLK3                  | Output   | Selectable 100/200 MHz Spread Spectrum differential compliment output clock 3.                           |
| 12    | CLK3                  | Output   | Selectable 100/200 MHz Spread Spectrum differential true output clock 3.                                 |
| 13    | CLK2                  | Output   | Selectable 100/200 MHz Spread Spectrum differential compliment output clock 2.                           |
| 14    | CLK2                  | Output   | Selectable 100/200 MHz Spread Spectrum differential true output clock 2.                                 |
| 15    | VDDODA                | Power    | Connect to a +3.3V analog source.  |
| 16    | GND                   | Power    | Output and Analog circuit ground   |
| 17    | CLK1                  | Output   | Selectable 100/200 MHz Spread Spectrum differential compliment output clock 1.                           |
| 18    | CLK1                  | Output   | Selectable 100/200 MHz Spread Spectrum differential true output clock 1.                                 |
| 19    | CLK0                  | Output   | Selectable 100/200 MHz Spread Spectrum differential compliment output clock 0.                           |
| 20    | CLK0                  | Output   | Selectable 100/200 MHz Spread Spectrum differential true output clock 0.                                 |

#### **Table 2: Spread Selection Table**

| S2 | S1 | S0 | Spread %  | Spread Type    | <b>Output Frequency</b> |
|----|----|----|-----------|----------------|-------------------------|
| 0  | 0  | 0  | -0.5      | Down           | 100                     |
| 0  | 0  | 1  | -1.0      | Down           | 100                     |
| 0  | 1  | 0  | -1.5      | Down           | 100                     |
| 0  | 1  | 1  | No Spread | Not Applicable | 100                     |
| 1  | 0  | 0  | -0.5      | Down           | 200                     |
| 1  | 0  | 1  | -1.0      | Down           | 200                     |
| 1  | 1  | 0  | -1.5      | Down           | 200                     |
| 1  | 1  | 1  | No Spread | Not Applicable | 200                     |





## **Application Information**

## **Decoupling Capacitors**

Decoupling capacitors of  $0.01\mu F$  or  $0.1\mu F$  must be connected between each VDD pin and the PCB ground plane and placed as close to the VDD pin as possible.

PI6C557-05B must be isolated from system power supply noise to perform optimally.

#### Crystal

Use a 25MHz fundamental mode parallel resonant crystal with less than 30PPM of error across temperature.

#### Current Source (Iref) Reference Resistor - R<sub>R</sub>

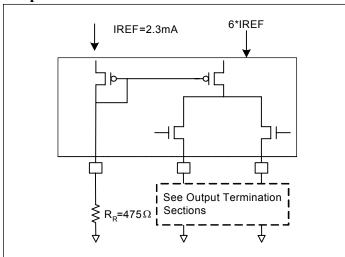
If board target trace impedance is 50-Ohm, then RR = 475-Ohm providing an IREF of 2.32 mA. The output current (IOH) is 6\*IREF.

#### **Output Termination**

The PCI-Express differential clock outputs of the PI6C557-05B are open source drivers and require an external series resistor and a resistor to ground. These resistor values and their allowable locations are shown in detail in the PCI-Express Layout Guidelines section.

The PI6C557-05B can be configured for LVDS compatible voltage levels. See the LVDS Compatible Layout Guidelines section.

## **Output Structures**







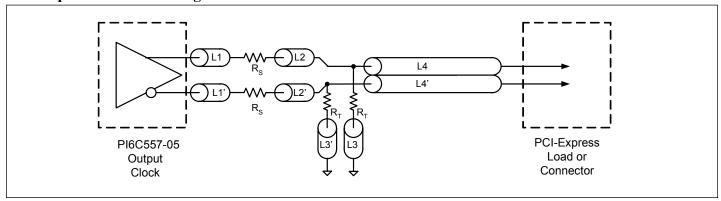
# **PCI-Express Layout Guidelines**

| Common Recommendations for Differential Routing | Dimension or Value | Unit |
|---|--------------------|------|
| L1 length, route as non-coupled 50-Ohm trace.   | 0.5 max            | inch |
| L2 length, route as non-coupled 50-Ohm trace.   | 0.2 max            | inch |
| L3 length, route as non-coupled 50-Ohm trace.   | 0.2 max            | inch |
| $R_{S}$   | 33                 | Ohm  |
| $R_{\mathrm{T}}$                                | 49.9               | Ohm  |

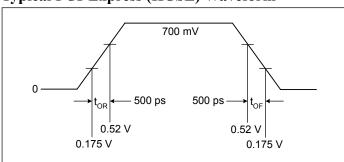
| Differential Routing on a Single PCB                               | Dimension or Value  | Unit |
|--|---------------------|------|
| L4 length, route as coupled microstrip 100-Ohm differential trace. | 2 min to 16 max     | inch |
| L4 length, route as coupled stripline 100-Ohm differential trace.  | 1.8 min to 14.4 max | inch |

| Differential Routing to a PCI Express connector                    | Dimension or Value    | Unit |
|--|-----------------------|------|
| L4 length, route as coupled microstrip 100-Ohm differential trace. | 0.25 min to 14 max    | inch |
| L4 length, route as coupled stripline 100-Ohm differential trace.  | 0.225 min to 12.6 max | inch |

# **PCI-Express Device Routing**



# Typical PCI-Express (HCSL) Waveform



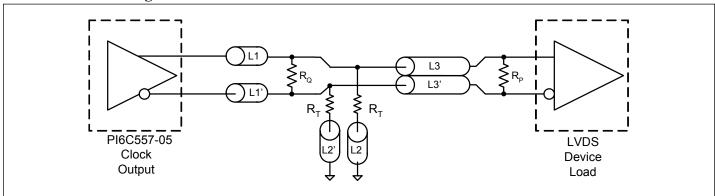




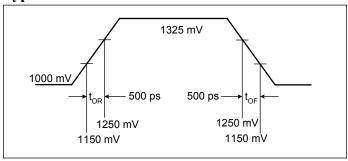
# **Application Information**

| LVDS Recommendations for Differential Routing       | Dimension or Value | Unit |
|---|--------------------|------|
| L1 length, route as non-coupled 50-Ohm trace.       | 0.5 max            | inch |
| L2 length, route as non-coupled 50-Ohm trace.       | 0.2 max            | inch |
| R <sub>P</sub>                                      | 100                | Ohm  |
| $R_{Q}$   | 100                | Ohm  |
| $R_{\mathrm{T}}$                                    | 150                | Ohm  |
| L3 length, route as $100\Omega$ differential trace. |                    |      |
| L3 length, route as $100\Omega$ differential trace. |                    |      |

# **LVDS Device Routing**



# **Typical LVDS Waveform**







# **Electrical Specifications**

## **Maximum Ratings**

| Supply Voltage to Ground Potential | 5.5V                          |
|------------------------------------|-------------------------------|
| All Inputs and Outputs             | 0.5V to V <sub>DD</sub> +0.5V |
| Ambient Operating Temperature      | -40 to +85°C                  |
| Storage Temperature                | -65 to +150°C                 |
| Junction Temperature               | 125°C                         |
| ESD Protection (Input)             | 2000V min (HBM)               |

#### Note:

Stresses greater than those listed under MAXIMUM RAT-INGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

## **Recommended Operation Conditions**

| Parameter   | Min.  | Тур. | Max.  | Unit |
|---|-------|------|-------|------|
| Ambient Operating Temperature                     | -40   |      | +85   | °C   |
| Power Supply Voltage (measured in respect to GND) | 3.135 |      | 3.465 | V    |

## **DC Characteristics** ( $V_{DD} = 3.3V \pm 5\%$ , $T_A = -40$ °C to +85°C)

| Symbol            | Parameter                         | Conditions                   |                                      | Min.     | Тур. | Max.     | Unit |
|-------------------|-----------------------------------|------------------------------|--------------------------------------|----------|------|----------|------|
| $V_{DD}$          | Supply Voltage                    |                              |                                      | 3.135    | 3.3  | 3.465    | V    |
| V <sub>IH</sub>   | Input High Voltage <sup>(1)</sup> |                              |                                      | 2.0      |      | VDD +0.3 | V    |
| $V_{\mathrm{IL}}$ | Input Low Voltage <sup>(1)</sup>  |                              |                                      | GND -0.3 |      | 0.8      | V    |
| I <sub>IL</sub>   | Input Leakage Current             | 0 < Vin < VDD                | Without input pull-up and pull-downs | -5       |      | 5        | μΑ   |
| $I_{DD}$          | $R_L = 50\Omega$                  |                              | pF @100MHz                           |          | 105  | 130      | mA   |
| $I_{DDOE}$        | Operating Supply Current          | OE = LOW                     |                                      |          | 40   | 50       | mA   |
| $I_{DDPD}$        |                                   | No load $\overline{PD} = LC$ | No load $\overline{PD} = LOW$        |          | 60   | 100      | μΑ   |
| C <sub>IN</sub>   | Input Capacitance                 | Input pin capacita           | ance                                 |          |      | 7        | pF   |
| C <sub>OUT</sub>  | Output Capacitance                | Output pin capacitance       |                                      |          |      | 6        | pF   |
| L <sub>PIN</sub>  | Pin Inductance                    |                              |                                      |          |      | 5        | nН   |
| R <sub>OUT</sub>  | Output Resistance                 | CLK Outputs                  |                                      | 3.0      |      |          | kΩ   |

#### Note

## AC Characteristics ( $V_{DD} = 3.3V \pm 5\%$ , $T_A = -40$ °C to +85°C)

| Symbol           | Parameter                           | Conditions                 | Min. | Тур. | Max. | Unit   |
|------------------|-------------------------------------|----------------------------|------|------|------|--------|
| F <sub>IN</sub>  | Input Frequency                     |                            |      | 25   |      | MHz    |
| V                | Output Fraguency                    | HCSL terminal              |      |      | 200  | MHz    |
| V <sub>OUT</sub> | Output Frequency                    | LVDS terminal              |      |      | 100  | IVITIZ |
| V <sub>OH</sub>  | Output High Voltage (1,2)           | @VDD = 3.3V                | 660  | 700  | 850  | mV     |
| $V_{ m OL}$      | Output Low Voltage <sup>(1,2)</sup> |                            | -150 | 0    | 27   | mV     |
| $V_{CPA}$        | Crossing Point Voltage(1,2)         | Absolute                   | 250  | 350  | 550  | mV     |
| V <sub>CN</sub>  | Crossing Point Voltage(1,2,4)       | Variation over all edges   |      |      | 140  | mV     |
| $J_{CC}$         | Jitter, Cycle-to-Cycle(1,3)         |                            |      | 40   | 60   | ps     |
| $J_{RMS2.0}$     | PCIe 2.0 RMS Jitter                 | PCI-SIG jitter test method |      |      | 3.1  | ps     |

<sup>1.</sup> Single edge is monotonic when transitioning through region.





#### **AC Characteristics Cont.**

| Symbol                  | Parameter                          | Conditions                         | Min. | Тур. | Max. | Unit |
|-------------------------|------------------------------------|------------------------------------|------|------|------|------|
|                         |                                    | PLL L-BW @ 2M & 5M<br>1st H3       |      | 2.1  | 3    | ps   |
| $J_{ m RMS3.0}$         | PCIe 3.0 RMS Jitter                | PLL L-BW @ 2M & 4M<br>1st H3       |      | 2.38 | 3    | ps   |
|                         | rcie 3.0 kms Julei                 | PLL H-BW @ 2M & 5M<br>1st H3       |      | 0.48 | 1    | ps   |
|                         |                                    | PLL H-BW @ 2M & 4M<br>1st H3       |      | 0.47 | 1    | ps   |
| MF                      | Modulation Frequency               | Spread Spectrum                    | 30   | 31.5 | 33   | kHz  |
| t <sub>OR</sub>         | Rise Time(1,2)                     | From 0.175V to 0.525V              | 175  | 332  | 700  | ps   |
| t <sub>OF</sub>         | Fall Time(1,2)                     | From 0.525V to 0.175V              | 175  | 344  | 700  | ps   |
| $T_{SKEW}$              | Skew between outputs               | At Crossing Point Voltage          |      |      | 50   | ps   |
| T <sub>DUTY-CYCLE</sub> | Duty Cycle <sup>(1,3)</sup>        |                                    | 45   |      | 55   | %    |
| T <sub>OE</sub>         | Output Enable Time(5)              | All outputs                        |      |      | 10   | μs   |
| T <sub>OT</sub>         | Output Disable Time(5)             | All outputs                        |      |      | 10   | μs   |
| t <sub>STABLE</sub>     | From power-up to VDD=3.3V          | From Power-up VDD=3.3V             |      | 3.0  |      | ms   |
| t <sub>SPREAD</sub>     | Setting period after spread change | Setting period after spread change |      | 3.0  |      | ms   |

- 1.  $R_L = 50$ -Ohm with  $C_L = 2$  pF and  $R_R$  2. Single-ended waveform
- 3. Differential waveform
- 4. Measured at the crossing point
- 5. CLK pins are tri-stated when OE is LOW

#### **Thermal Characteristics**

| Symbol           | Parameter                              | Conditions | Min. | Тур. | Max. | Unit |
|------------------|--|------------|------|------|------|------|
| $\theta_{ m JA}$ | Thermal Resistance Junction to Ambient | Still air  |      |      | 93   | °C/W |
| $\theta_{ m JB}$ | Thermal Resistance Junction to Board   |            |      |      | 54   | °C/W |
| $\theta_{ m JC}$ | Thermal Resistance Junction to Case    |            |      |      | 20   | °C/W |

#### **Recommended Crystal Specification**

#### Diodes recommends:

- a) GC2500003 XTAL 49S/SMD(4.0 mm), 25M, CL=18pF, +/-30ppm http://www.pericom.com/pdf/datasheets/se/GC\_GF.pdf
- b) FY2500081, SMD 5x3.2(4P), 25M, CL=18pF, +/-30ppm http://www.pericom.com/pdf/datasheets/se/FY\_F9.pdf
- c) FL2500047, SMD 3.2x2.5(4P), 25M, CL=18pF, +/-20ppm http://www.pericom.com/pdf/datasheets/se/FL.pdf





## **Part Marking**

PI6C557 -05BLE YYWWXX

YY: Year

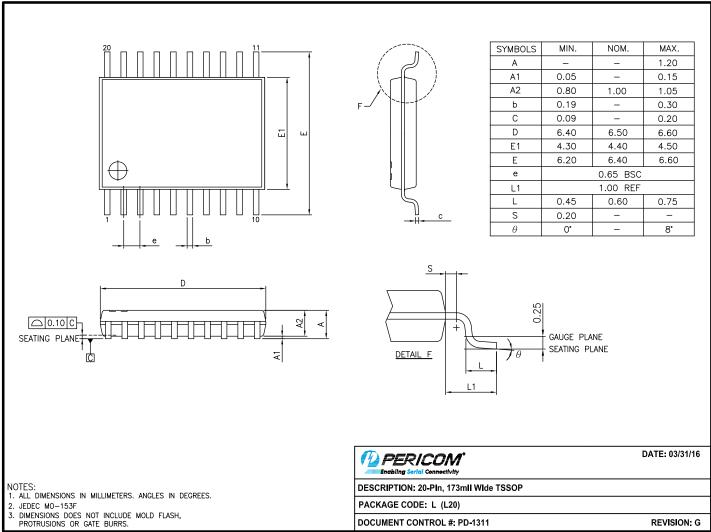
WW: Workweek

1st X: Assembly Code 2nd X: Fab Code





## Packaging Mechanical: 20-TSSOP(L)



16-0074

#### For latest package info.

 $please\ check: http://www.diodes.com/design/support/packaging/pericom-packaging/packaging-mechanicals-and-thermal-characteristics/packaging-mech$ 

## **Ordering Information**

| Ordering Code  | Package Code | Package Description         |
|----------------|--------------|-----------------------------|
| PI6C557-05BLEX | L            | 20-Pin, 173mil Wide (TSSOP) |

#### Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. E = Pb-free and Green
- 5. X suffix = Tape/Reel





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